

Switching Diodes Silicon Epitaxial Planar

1SS387CT

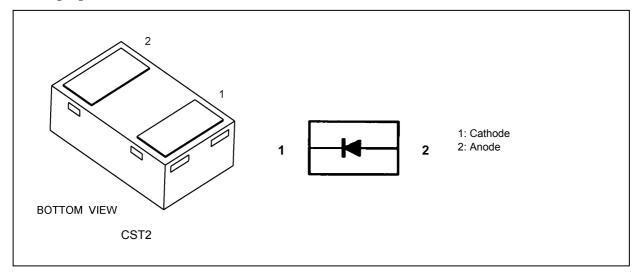
1. Applications

• Ultra-High-Speed Switching

2. Features

- (1) Small package
- (2) Low forward voltage: $V_{F(3)} = 0.98 \text{ V (typ.)}$
- (3) Fast reverse recovery time: $t_{rr} = 1.6 \text{ ns (typ.)}$
- (4) Small total capacitance: $C_t = 0.5 \text{ pF (typ.)}$

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Rating	Unit
Peak reverse voltage	V_{RM}		85	V
Reverse voltage	V _R		80	
Peak forward current	I _{FM}		200	mA
Average rectified current	I _O		100	
Non-repetitive peak forward surge current	I _{FSM}		1	Α
Power dissipation	P _D	(Note 1)	150	mW
Junction temperature	Tj		150	ç
Storage temperature	T _{stg}		-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on a glass epoxy circuit board of 20 mm × 20 mm, Pad dimension of 4 mm × 4 mm.

5. Electrical Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	$V_{F(1)}$	I _F = 1 mA		0.62	_	V
	$V_{F(2)}$	I _F = 10 mA		0.75	_	
	$V_{F(3)}$	I _F = 100 mA	_	0.98	1.2	
Reverse current	I _{R(1)}	V _R = 30 V	-		0.1	μА
	I _{R(2)}	V _R = 80 V		_	0.5	
Total capacitance	Ct	V _R = 0 V, f = 1 MHz	_	0.5	_	pF
Reverse recovery time	t _{rr}	I _F = 10 mA See Fig. 5.1.	_	1.6	_	ns

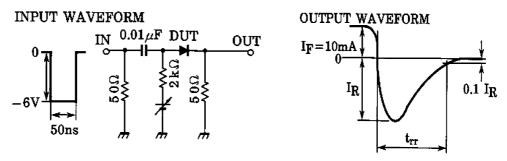
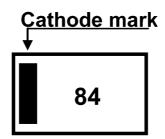
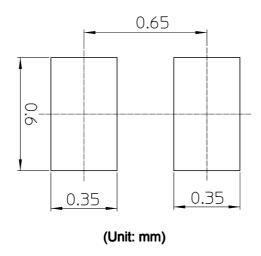


Fig. 5.1 Reverse recovery time (t_{rr}) Test circuit

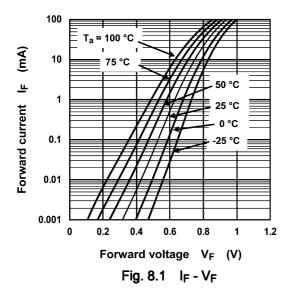
6. Marking

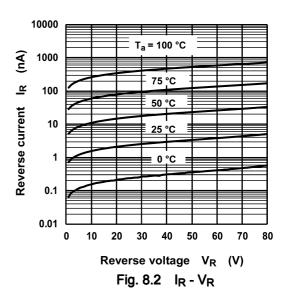


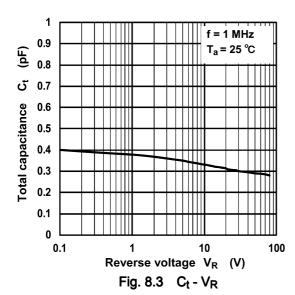
7. Land Pattern Dimensions (for reference only)

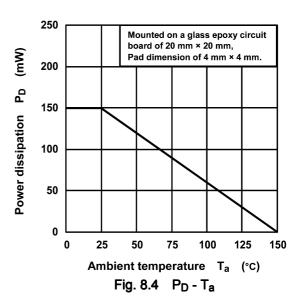


8. Characteristics Curves (Note)







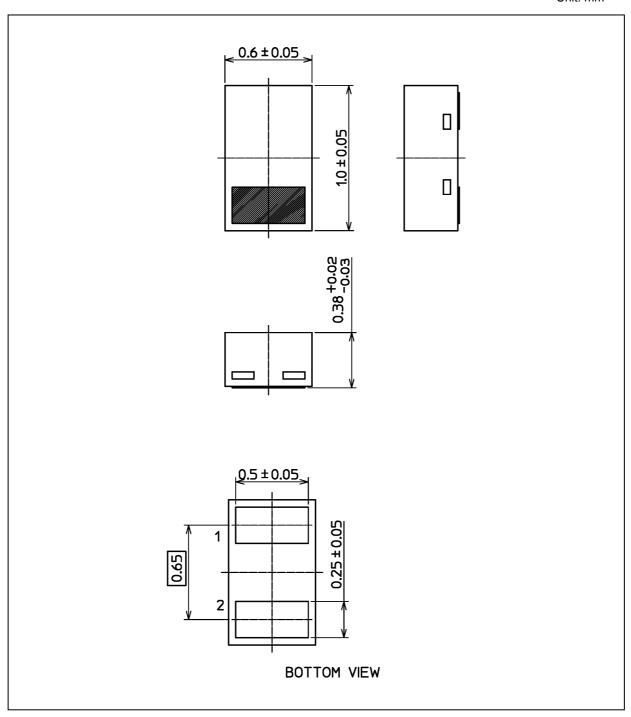


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 0.7 mg (typ.)

	Package Name(s)
TOSHIBA: 1-1P1S	
Nickname: CST2	



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2014-04-04

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